

FS70SM-2-A8-VB Datasheet N-Channel 100-V (D-S) MOSFET

PRODUCT	SUMMARY	
V _{(BR)DSS} (V)	$r_{DS(on)}(\Omega)$	I _D (A)
100	0.018 at V _{GS} = 10 V	65 ^a

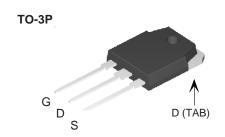
FEATURES

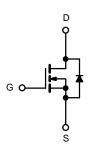
- Trench Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- 100 % R_g Tested



APPLICATIONS

• Isolated DC/DC Converters





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _C = 25 °C, unless oth	erwise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	100	V	
Gate-Source Voltage		V _{GS}	± 20	v	
Continuous Drain Current (T _{.1} = 175 °C)	T _C = 25 °C	ID	65 ^a		
Continuous Drain Current (1j = 173 C)	T _C = 125 °C	'b	31 ^a	A	
Pulsed Drain Current		I _{DM}	140	1 A	
Avalanche Current	L = 0.1 mH	I _{AS}	31		
Single Pulse Avalanche Energy ^b	L = 0.1 IIII1	E _{AS}	60	mJ	
Maximum Power Dissipation ^b	T _C = 25 °C	D.	355 ^c	W	
	T _A = 25 °C ^d	$ P_D$ $-$	3.35	VV	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS				
Parameter		Symbol	Limit	Unit
Junction-to-Ambient	PCB Mount	R _{thJA}	40	°C/W
Junction-to-Case (Drain)		R _{thJC}	0.4	C/VV

Notes:

- a. Package limited.
- b. Duty cycle \leq 1 %.
- c. See SOA curve for voltage derating.
- d. When Mounted on 1" square PCB (FR-4 material).



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	100			V	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2		4		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current		$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}$			1		
	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V, T _J = 125 °C			50	μA	
		V _{DS} = 100 V, V _{GS} = 0 V, T _J = 175 °C			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α	
Drain-Source On-State Resistance ^a		V _{GS} = 10 V, I _D = 30 A		0.018		Ω	
	r _{DS(on)}	V _{GS} = 10 V, I _D = 30 A, T _J = 125 °C		0.023			
		V _{GS} = 10 V, I _D = 30 A, T _J = 175 °C		0.037			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	25			S	
Dynamic ^b							
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V, f = 1 MHz		3200		pF	
Output Capacitance	C _{oss}			410			
Reverse Transfer Capacitance	C _{rss}			210			
Total Gate Charge ^c	Q_g			90	130	nC	
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 58 \text{ A}$		23			
Gate-Drain Charge ^c	Q_{gd}			34			
Gate Resistance	R_g		0.5	1.3	3.1	Ω	
Turn-On Delay Time ^c	t _{d(on)}			24	35	ns	
Rise Time ^c	t _r	V_{DD} = 100 V, R_L = 1.5 Ω I_D \cong 58 A, V_{GEN} = 10 V, R_g = 2.5 Ω		220	330		
Turn-Off Delay Time ^c	t _{d(off)}			45	70		
Fall Time ^c	t _f			200	300		
Source-Drain Diode Ratings and Ch	aracteristics 7	T _C = 25 °C ^b					
Continuous Current	I _S				58	Δ	
Pulsed Current	I _{SM}				110	A	
Forward Voltage ^a	V_{SD}	I _F = 58 A, V _{GS} = 0 V		1.0	1.5	V	
Reverse Recovery Time	t _{rr}			130	200	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 30 A, di/dt = 100 A/μs		8	12	Α	
Reverse Recovery Charge	Q _{rr}			0.52	1.2	иC	

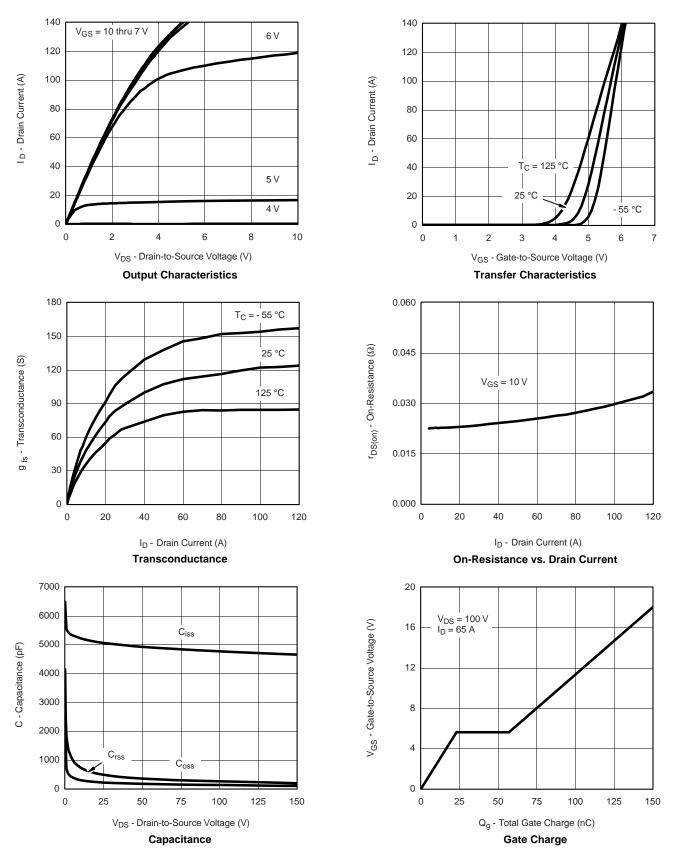
Notes:

- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

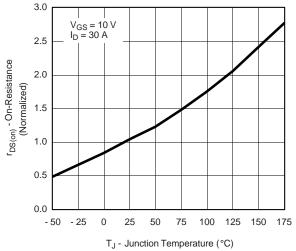


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

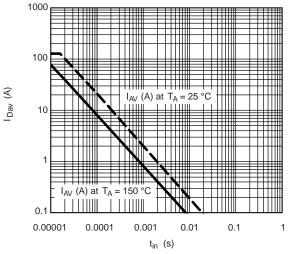




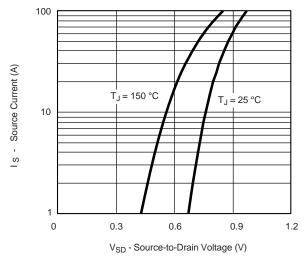
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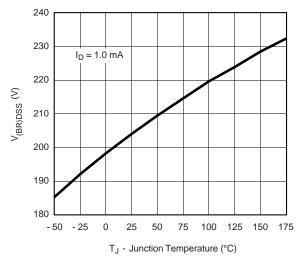
On-Resistance vs. Junction Temperature



Avalanche Current vs. Time



Source-Drain Diode Forward Voltage

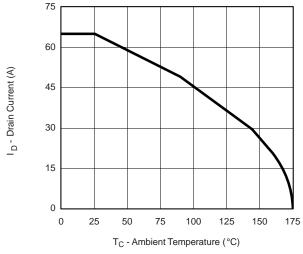


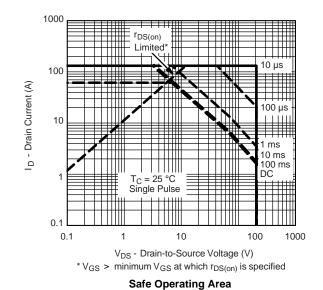
Drain Source Breakdown vs. Junction Temperature



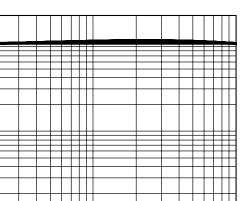
THERMAL RATINGS

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Maximum Avalanche and Drain Current vs. Case Temperature

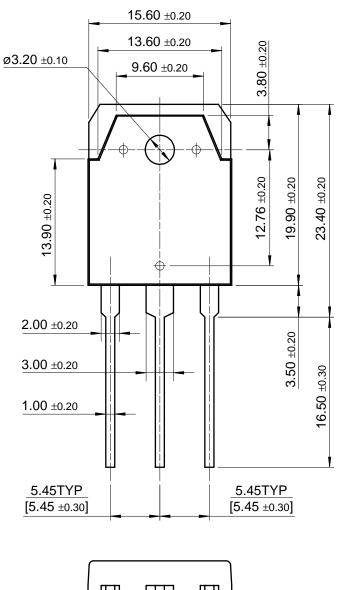


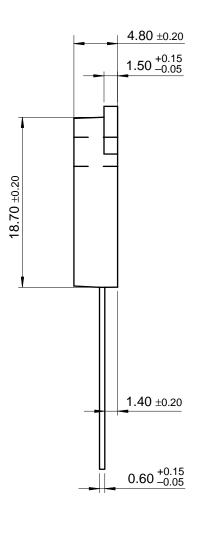
Duty Cycle = 0.5 Normalized Effective Transient Thermal Impedance Single Pulse 0.01 10⁻³ 10-4 10⁻² 10-1 Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Case



TO-3P







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